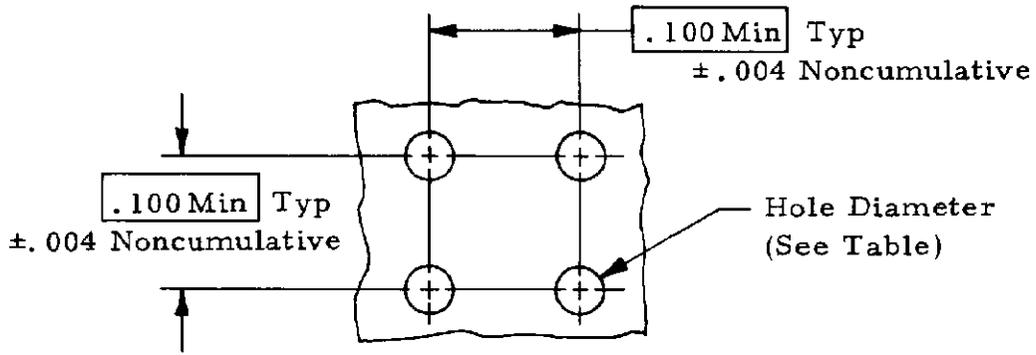


C. Layout shall be as indicated in Figure 2.



Required Drill Size	Hole Dia ±.0010	Plating Thickness		Hole Diameter		Copper Hardness, Knoop
		Copper	Tin/Lead	After Plating	After Reflow	
1.15 mm	.0453	.001-.003	.0003 min	.037-.043	.036-.043	150 max

Figure 2

3.2. Cutoff Tab and Burr

A. Cutoff tabs shall not exceed the limits specified in Figure 3.

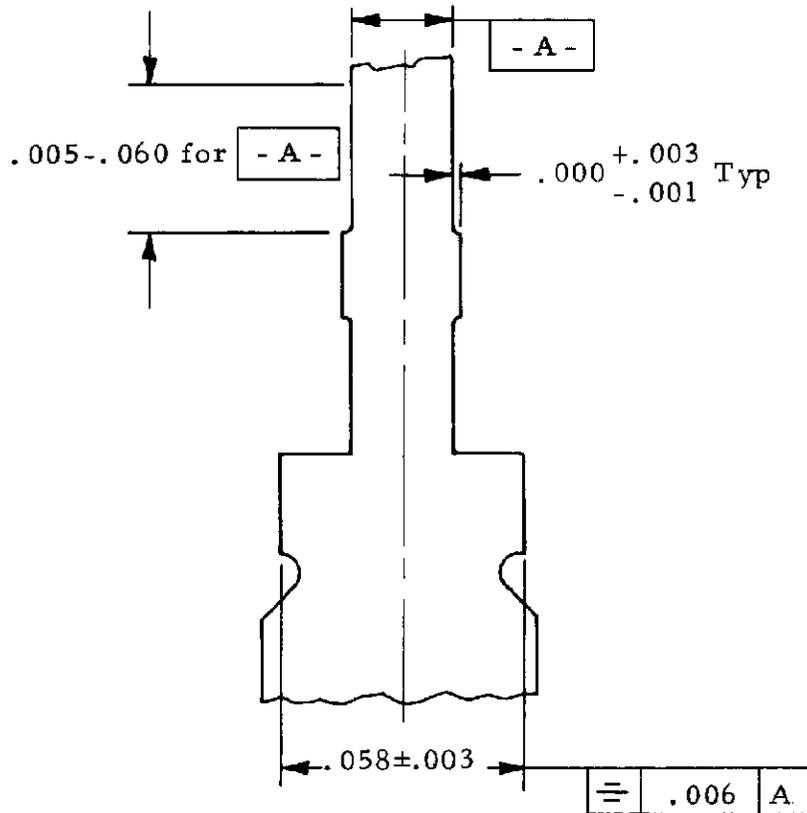


Figure 3

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B. Burr on cutoff tabs shall not exceed .003.

3.3. Insertion

Posts shall be inserted in the printed circuit board within limits specified in Figure 4.

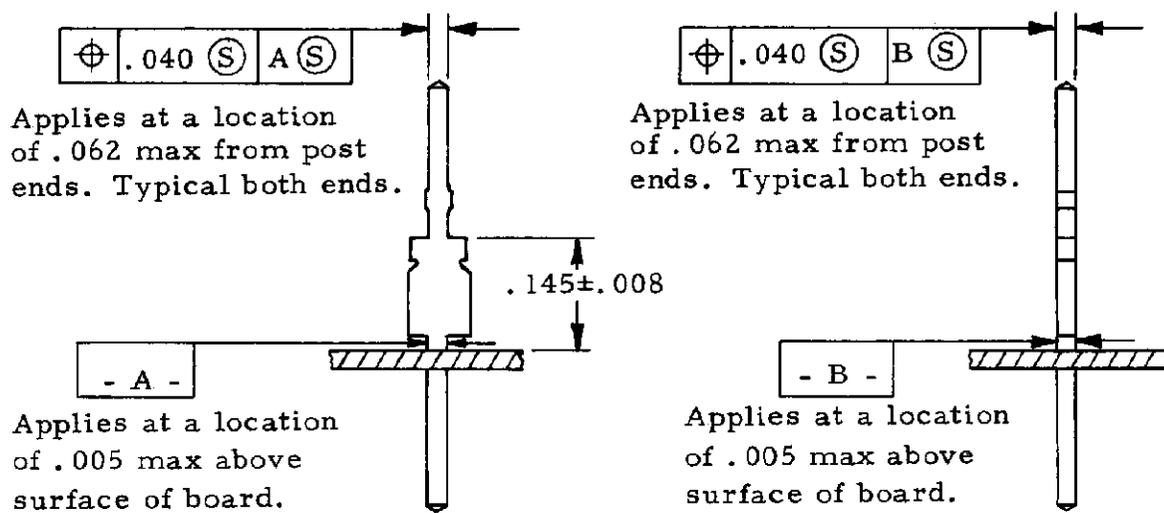


Figure 4

3.4. Rotation

Post shall be parallel to the datum line as indicated in Figure 5.

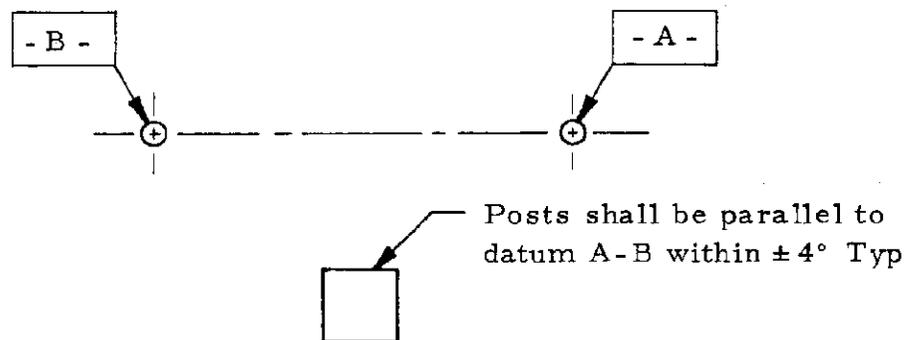


Figure 5

3.5. Workmanship

Damage to the circuitry on either side of the printed circuit board is not permissible.

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